

4AM14

Silicon N-Channel/P-Channel Complementary Power MOS FET
Array

HITACHI

ADE-208-1212 (Z)
1st. Edition
Mar. 2001

Application

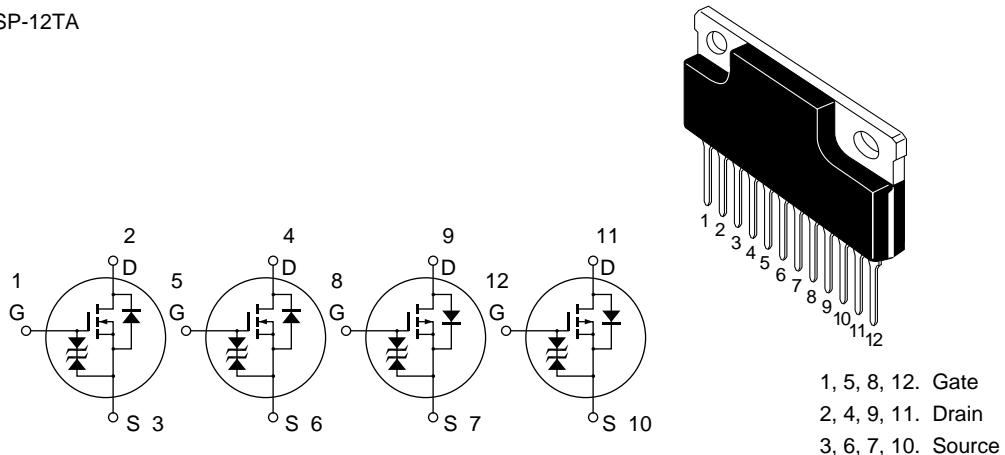
High speed power switching

Features

- Low on-resistance
N-channel: $R_{DS(on)} \leq 0.17$, $V_{GS} = 10$ V, $I_D = 4$ A
P-channel: $R_{DS(on)} \leq 0.2$, $V_{GS} = -10$ V, $I_D = -4$ A
- Capable of 4 V gate drive
- Low drive current
- High speed switching
- High density mounting
- Suitable for H-bridged motor driver

Outline

SP-12TA



Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings		
		Nch	Pch	Unit
Drain to source voltage	V_{DSS}	60	-60	V
Gate to source voltage	V_{GSS}	± 20	± 20	V
Drain current	I_D	8	-8	A
Drain peak current	$I_{D(\text{pulse})}^{*1}$	32	-32	A
Body to drain diode reverse drain current	I_{DR}	8	-8	A
Channel dissipation	P_{ch} ($T_c = 25^\circ\text{C}$) ^{*2}	32		W
Channel dissipation	P_{ch}^{*2}	4		W
Channel temperature	T_{ch}	150		$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150		$^\circ\text{C}$

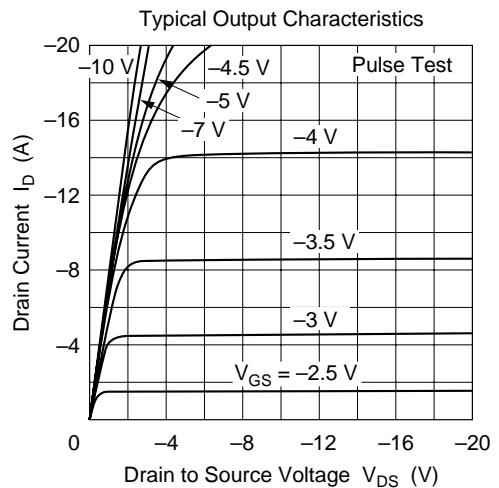
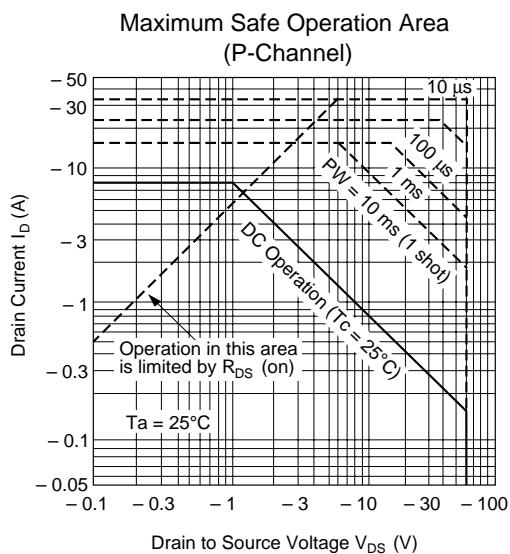
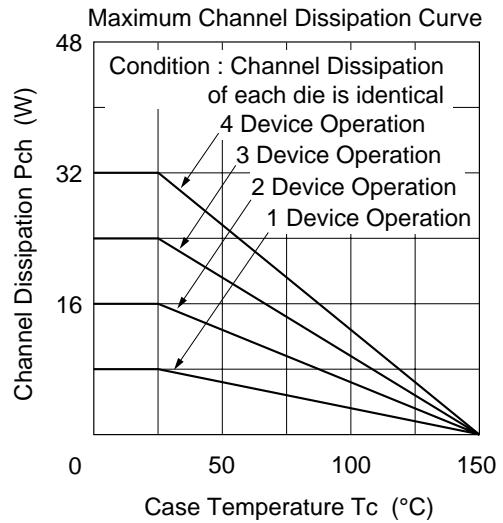
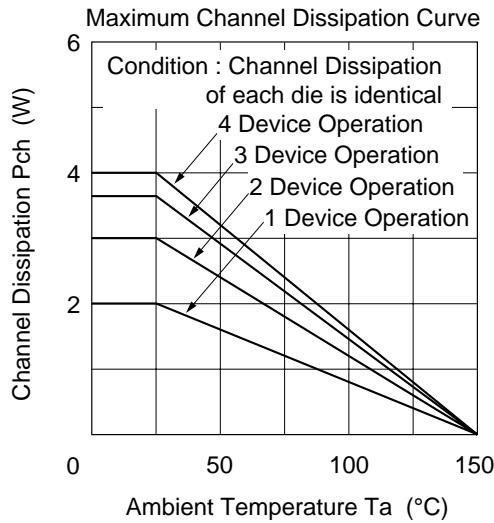
Notes: 1. $PW \leq 10 \mu\text{s}$, duty cycle $\leq 1\%$
 2. 4 devices operation

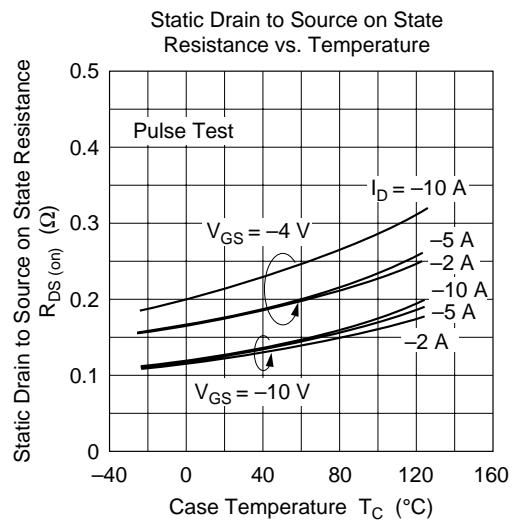
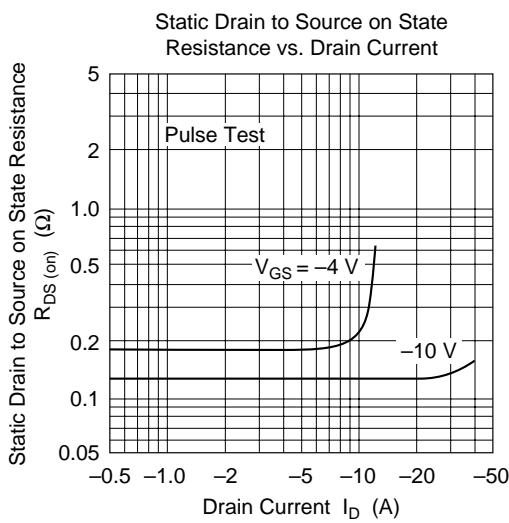
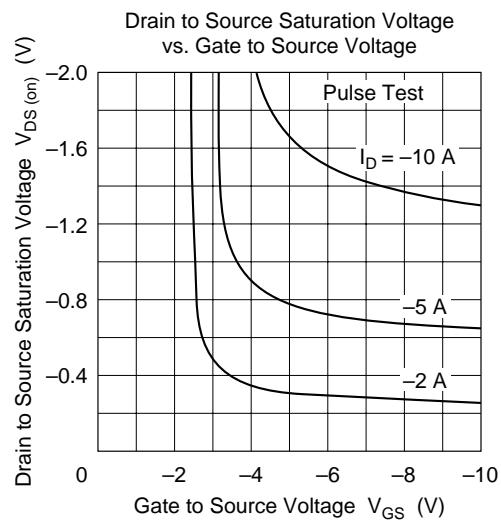
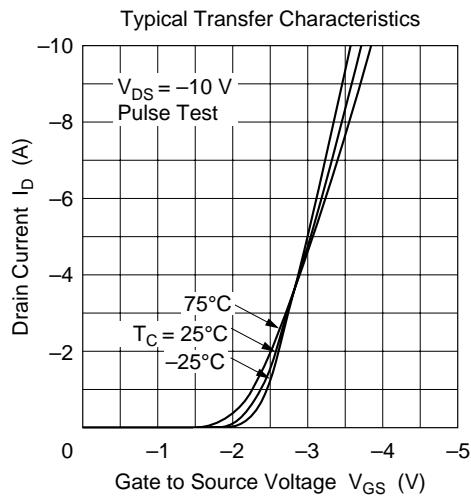
Electrical Characteristics (Ta = 25°C) (1 Unit)

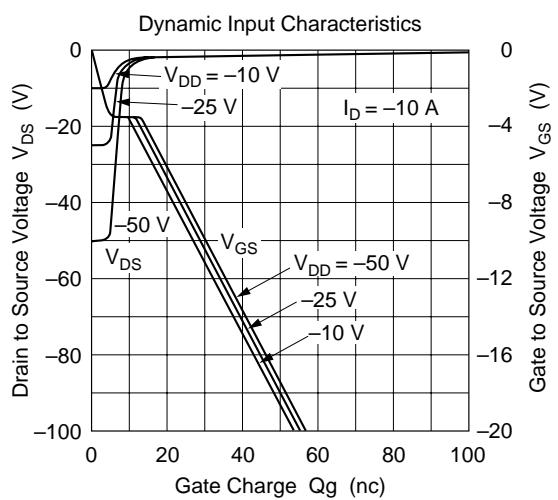
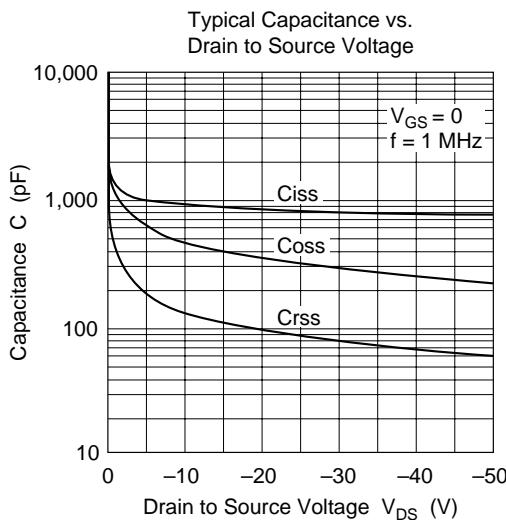
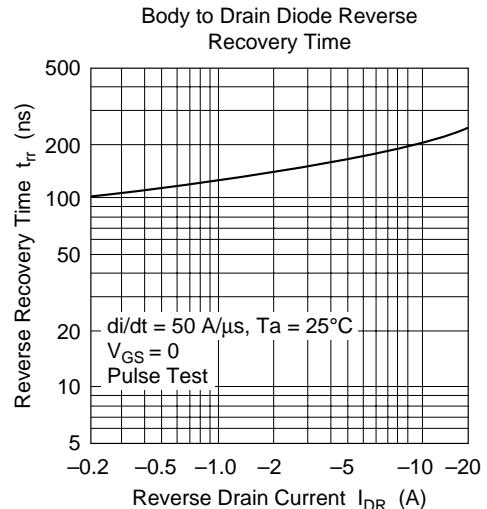
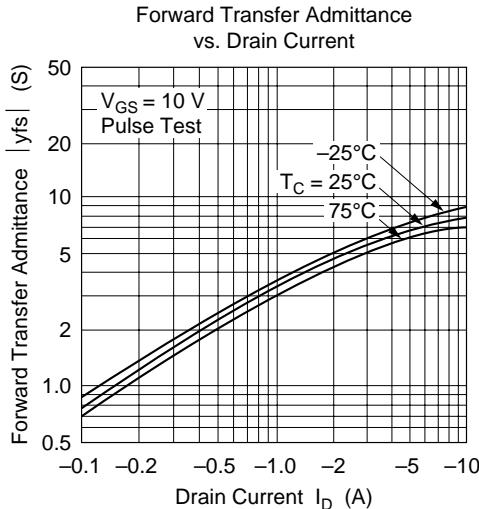
Item	Symbol	N channel			P channel			Unit	Test conditions
		Min	Typ	Max	Min	Typ	Max		
Drain to source breakdown voltage	V _{(BR)DSS}	60	—	—	-60	—	—	V	I _D = 10 mA, V _{GS} = 0
Gate to source breakdown voltage	V _{(BR)GSS}	±20	—	—	±20	—	—	V	I _G = ±100 µA, V _{DS} = 0
Gate to source leak current	I _{GSS}	—	—	±10	—	—	±10	µA	V _{GS} = ±16 V, V _{DS} = 0
Zero gate voltage drain current	I _{DSS}	—	—	250	—	—	-250	µA	V _{DS} = 50 V, V _{GS} = 0
Gate to source cutoff voltage	V _{GS(off)}	1.0	—	2.0	-1.0	—	-2.0	V	I _D = 1 mA, V _{DS} = 10 V
Static drain to source on state resistance	R _{DS(on)}	—	0.13	0.17	—	0.15	0.2	Ω	I _D = 4 A, V _{GS} = 10 V ^{*1}
		—	0.18	0.24	—	0.20	0.27	Ω	I _D = 4 A, V _{GS} = 4 V ^{*1}
Forward transfer admittance	y _{fs}	3.5	5.5	—	3.5	6.0	—	S	I _D = 4 A, V _{DS} = 10 V ^{*1}
Input capacitance	C _{iss}	—	400	—	—	900	—	pF	V _{DS} = 10 V, V _{GS} = 0,
Output capacitance	C _{oss}	—	220	—	—	460	—	pF	f = 1 MHz
Reverse transfer capacitance	C _{rss}	—	60	—	—	130	—	pF	
Turn-on delay time	t _{d(on)}	—	5	—	—	8	—	ns	I _D = 4 A, V _{GS} = 10 V,
Rise time	t _r	—	45	—	—	50	—	ns	R _L = 7.5 Ω
Turn-off delay time	t _{d(off)}	—	150	—	—	180	—	ns	
Fall time	t _f	—	85	—	—	95	—	ns	
Body to drain diode forward voltage	V _{DF}	—	1.2	—	—	-1.2	—	V	I _F = 8 A, V _{GS} = 0
Body to drain diode reverse recovery time	t _{rr}	—	120	—	—	185	—	ns	I _F = 8 A, V _{GS} = 0, dI/F/dt = 50 A/µs

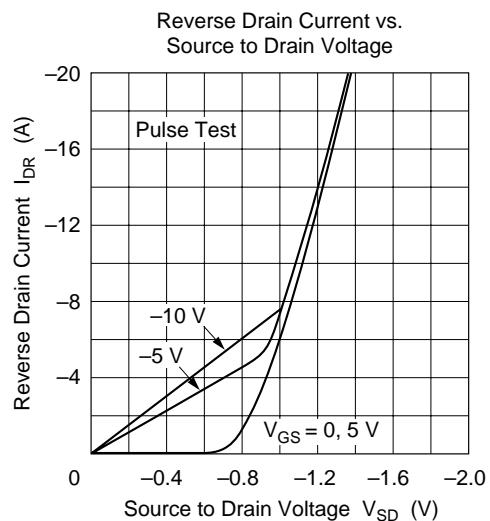
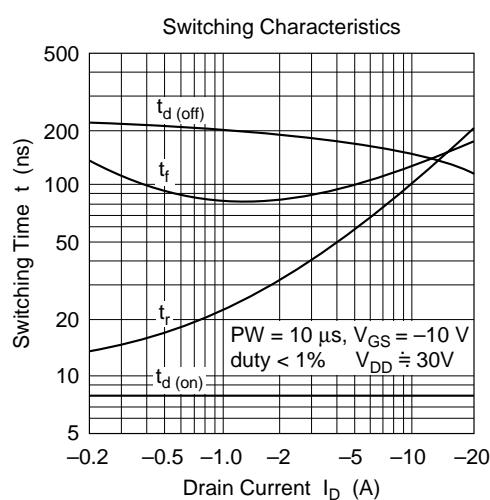
Note: 1. Pulse Test

Polarity of test conditions for P channel device is reversed.

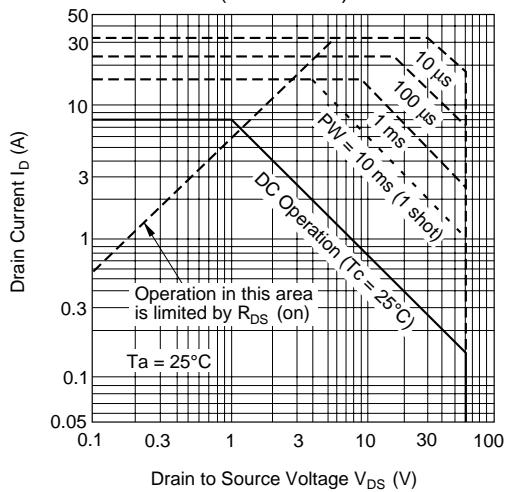




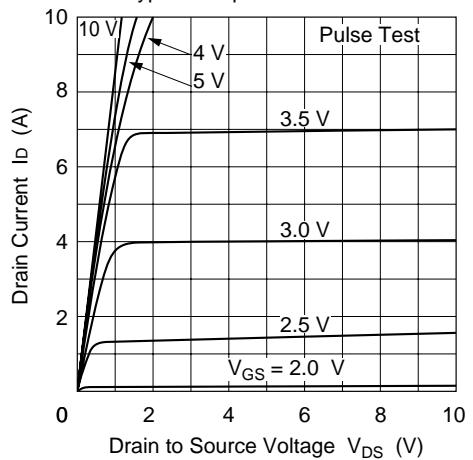




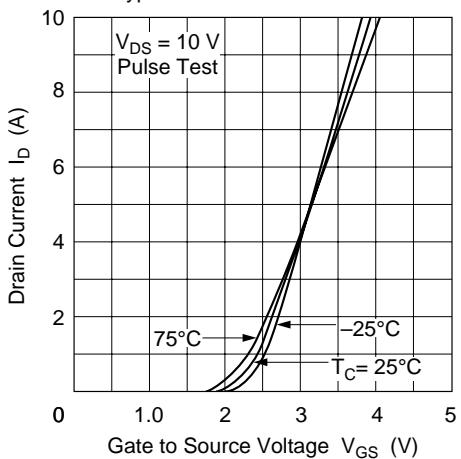
Maximum Safe Operation Area
(N-Channel)



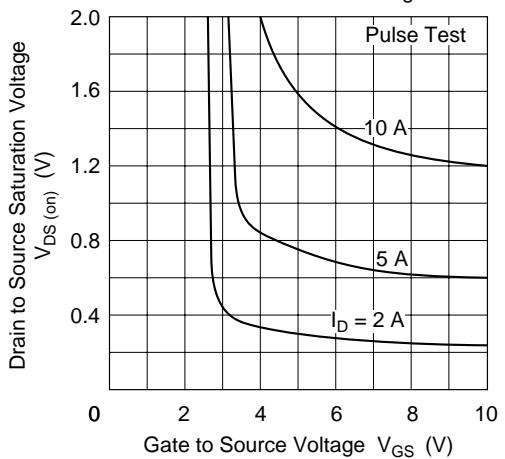
Typical Output Characteristics

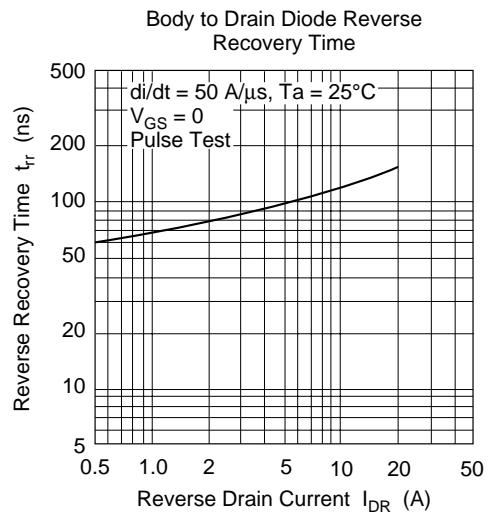
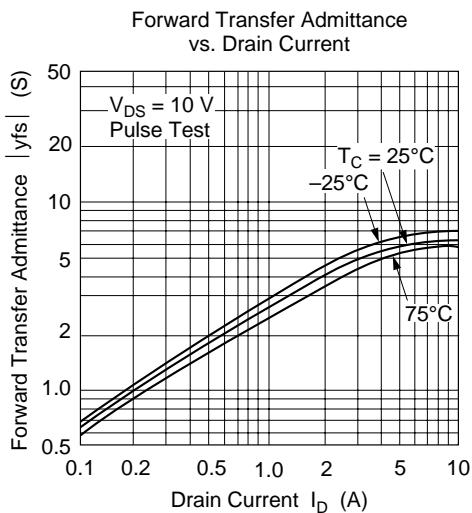
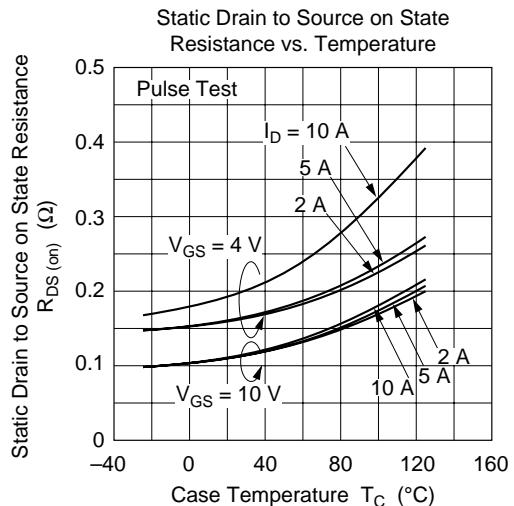
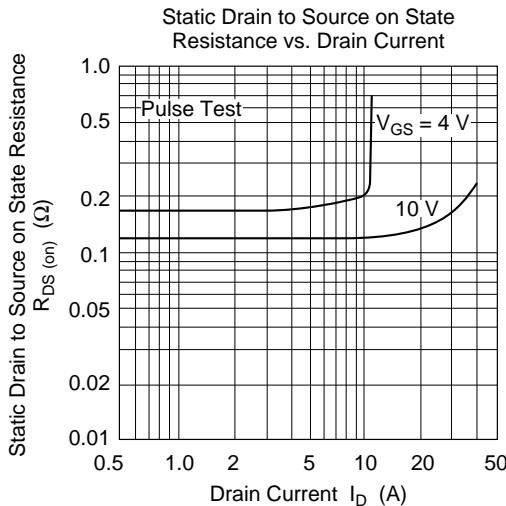


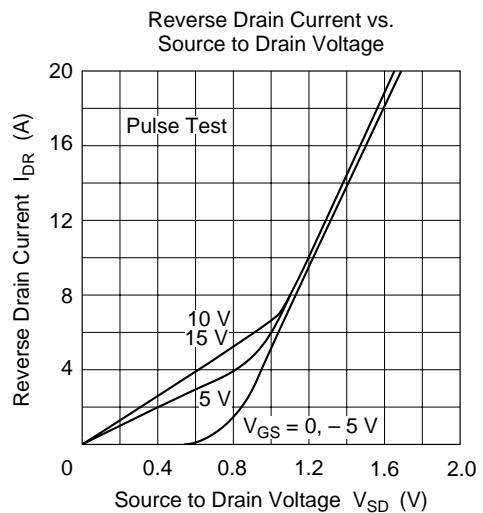
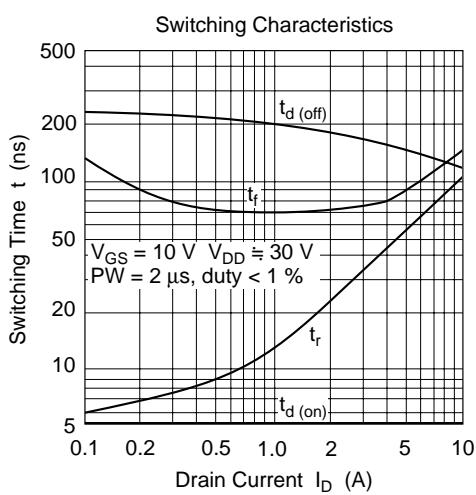
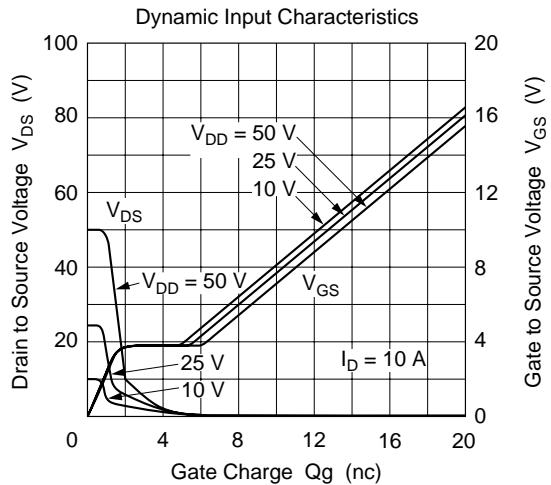
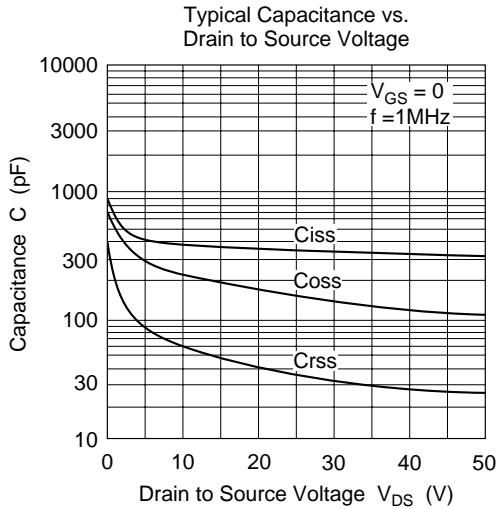
Typical Transfer Characteristics



Drain to Source Saturation Voltage vs. Gate to Source Voltage

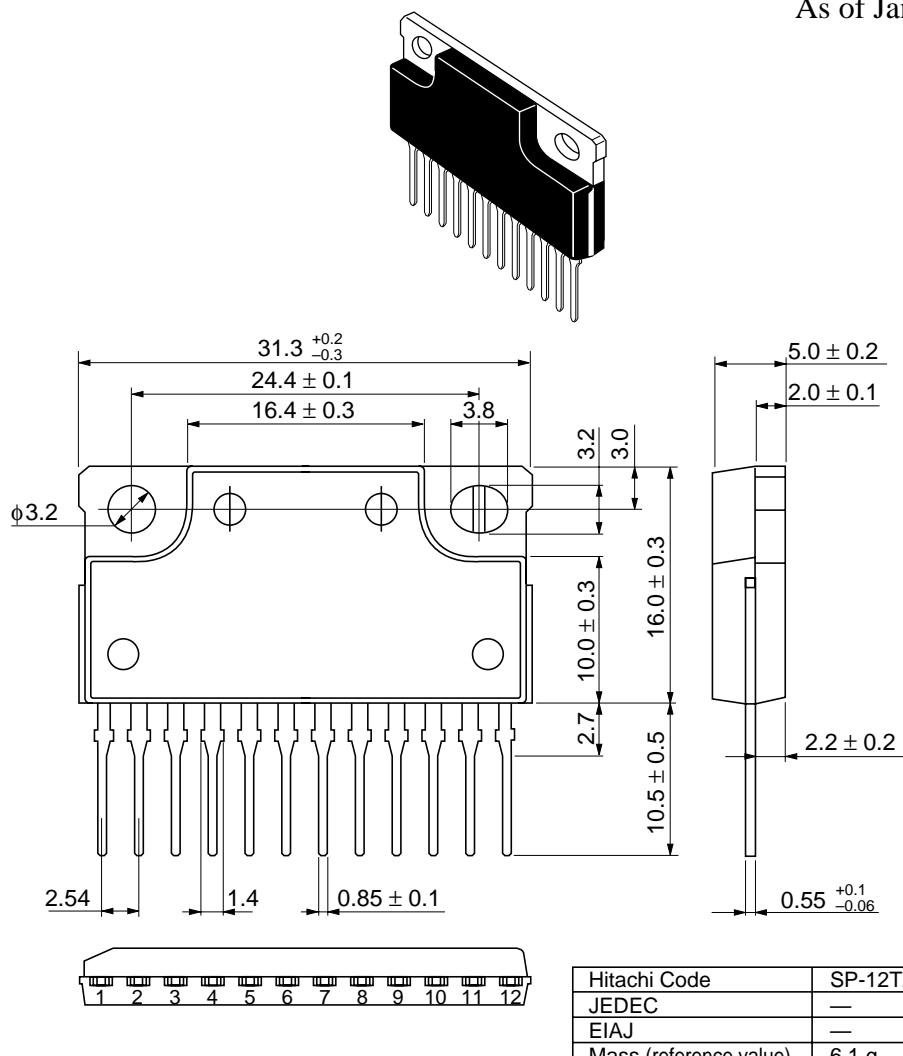






Package Dimensions

As of January, 2001
Unit: mm



Hitachi Code	SP-12TA
JEDEC	—
EIAJ	—
Mass (reference value)	6.1 g

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Hitachi, Ltd.

Semiconductor & Integrated Circuits.

Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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